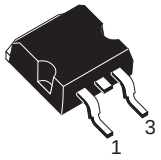
STB85NF3LL

N-CHANNEL 30V - 0.006Ω - 85A D^2PAK
LOW GATE CHARGE STripFET™II POWER MOSFET

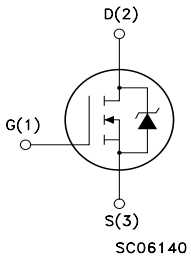
TYPE	V_{DSS}	$R_{DS(on)}$	I_D
STB85NF3LL	30 V	< 0.008 Ω	85 A

- TYPICAL $R_{DS}(on)$ = 0.0075Ω (@4.5V)
- OPTIMAL $R_{DS}(on)$ x Qg TRADE-OFF @4.5V
- CONDUCTION LOSSES REDUCED
- SWITCHING LOSSES REDUCED
- ADD SUFFIX “T4” FOR ORDERING IN TAPE & REEL



D^2PAK

INTERNAL SCHEMATIC DIAGRAM



DESCRIPTION

This application specific Power MOSFET is the third genaration of STMicroelectronics unique “ Single Feature Size” strip-based process. The resulting transistor shows the best trade-off between on-resistance and gate charge. When used as high and low side in buck regulators, it gives the best performance in terms of both conduction and switching losses. This is extremely important for motherboards where fast switching and high efficiency are of paramount importance.

APPLICATIONS

- SPECIFICALLY DESIGNED AND OPTIMISED FOR HIGH EFFICIENCY CPU CORE DC/DC CONVERTERS

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source Voltage (V_{GS} = 0)	30	V
V_{DGR}	Drain-gate Voltage (R_{GS} = 20 kΩ)	30	V
V_{GS}	Gate- source Voltage	± 16	V
V_{GSM}	Gate-source Voltage Pulsed (t_p≤50µs; duty cycle 25%; T_j ≤ 150°C)	± 20	V
I_D	Drain Current (continuos) at T_C = 25°C	85	A
I_D	Drain Current (continuos) at T_C = 100°C	60	A
I_{DM} (●)	Drain Current (pulsed)	340	A
P_{TOT}	Total Dissipation at T_C = 25°C	110	W
	Derating Factor	0.73	W/°C
T_{stg}	Storage Temperature	–65 to 175	°C
T_j	Max. Operating Junction Temperature	175	°C

(●) Pulse width limited by safe operating area

THERMAL DATA

Rthj-case	Thermal Resistance Junction-case Max	1.36	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	62.5	°C/W
T_l	Maximum Lead Temperature For Soldering Purpose	300	°C

ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown Voltage	I_D = 250 µA, V_{GS} = 0	30			V
I_{DSS}	Zero Gate Voltage Drain Current (V_{GS} = 0)	V_{DS} = Max Rating			1	µA
		V_{DS} = Max Rating, T_C = 125 °C			10	µA
I_{GSS}	Gate-body Leakage Current (V_{DS} = 0)	V_{GS} = ± 16V			±100	nA

ON (1)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250µA	1			V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{GS} = 10V, I_D = 40 A		0.006	0.008	Ω
		V_{GS} = 4.5V, I_D = 40 A		0.0075	0.0095	Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs} (1)	Forward Transconductance	V_{DS} > $I_{D(on)}$ x $R_{DS(on)max}$, I_D = 40 A		30		S
C_{iss}	Input Capacitance	V_{DS} = 25V, f = 1 MHz, V_{GS} = 0		2210		pF
C_{oss}	Output Capacitance			635		pF
C_{rss}	Reverse Transfer Capacitance			138		pF

ELECTRICAL CHARACTERISTICS (CONTINUED)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	V_{DD} = 15V, I_D = 30A		22		ns
t_r	Rise Time	R_G = 4.7Ω V_{GS} = 4.5V (see test circuit, Figure 3)		130		ns
Q_g	Total Gate Charge	V_{DD} = 24V, I_D = 60A,		30	40	nC
Q_{gs}	Gate-Source Charge	V_{GS} = 4.5V		9		nC
Q_{gd}	Gate-Drain Charge			12.5		nC

SWITCHING OFF

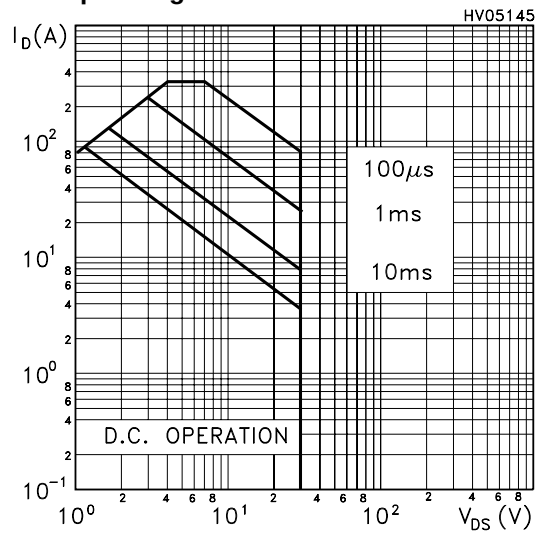
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$	Turn-off-Delay Time	V_{DD} = 15V, I_D = 30A,		36.5		ns
t_f	Fall Time	R_G = 4.7Ω, V_{GS} = 4.5V (see test circuit, Figure 3)		36.5		ns
$t_{d(off)}$	Off-voltage Rise Time	Vclamp =24V, I_D =30A		32		ns
t_f	Fall Time	R_G = 4.7Ω, V_{GS} = 4.5V		23		ns
t_c	Cross-over Time	(see test circuit, Figure 5)		40		ns

SOURCE DRAIN DIODE

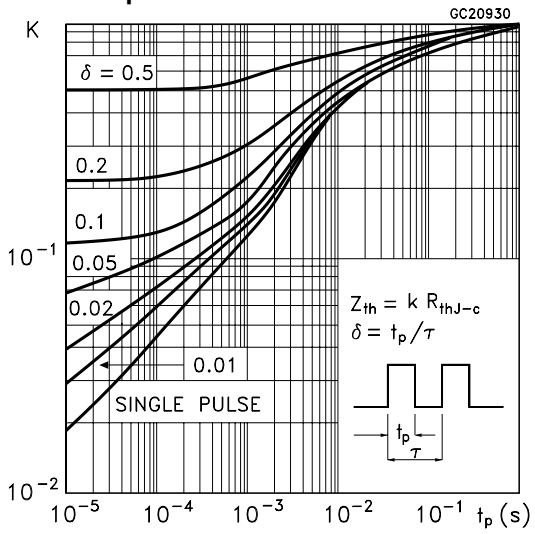
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain Current				85	A
I_{SDM} (2)	Source-drain Current (pulsed)				340	A
V_{SD} (1)	Forward On Voltage	I_{SD} = 85A, V_{GS} = 0			1.3	V
t_{rr}	Reverse Recovery Time	I_{SD} = 85A, di/dt = 100A/µs,		65		ns
Q_{rr}	Reverse Recovery Charge	V_{DD} = 15V, T_j = 150°C		105		nC
I_{RRM}	Reverse Recovery Current	(see test circuit, Figure 5)		3.4		A

Note: 1. Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.
2. Pulse width limited by safe operating area.

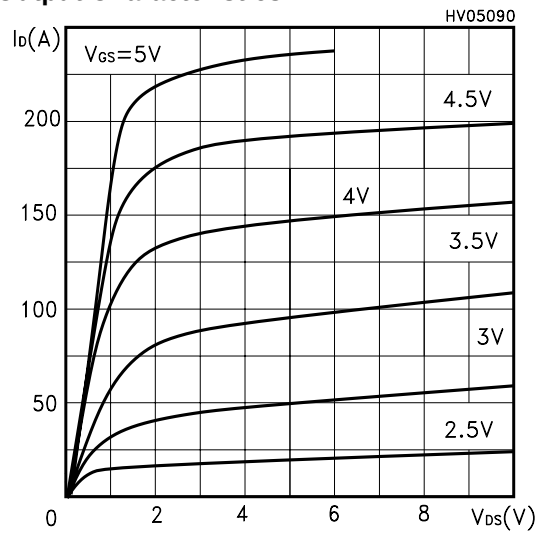
Safe Operating Area



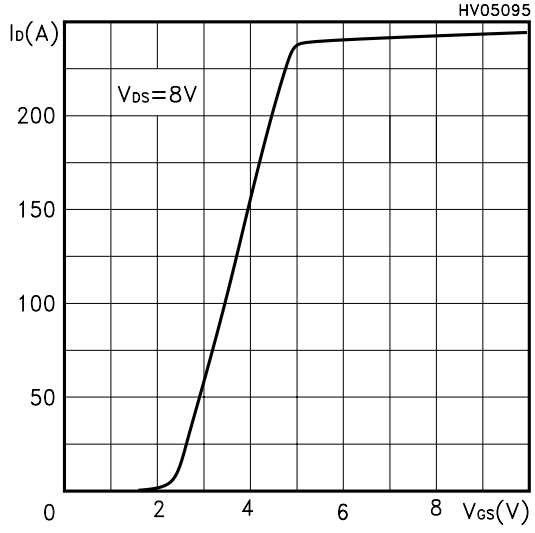
Thermal Impedence



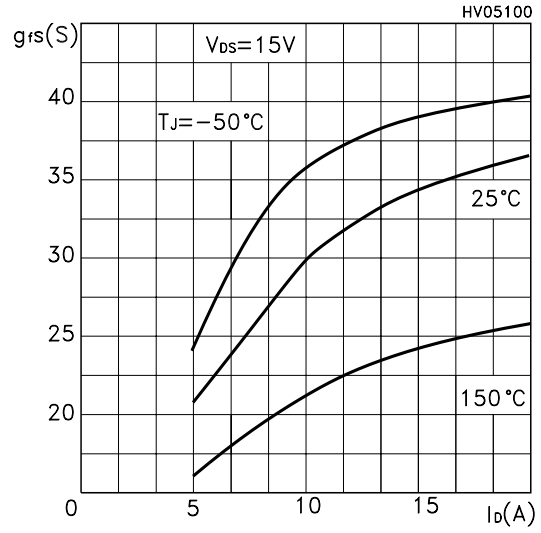
Output Characteristics



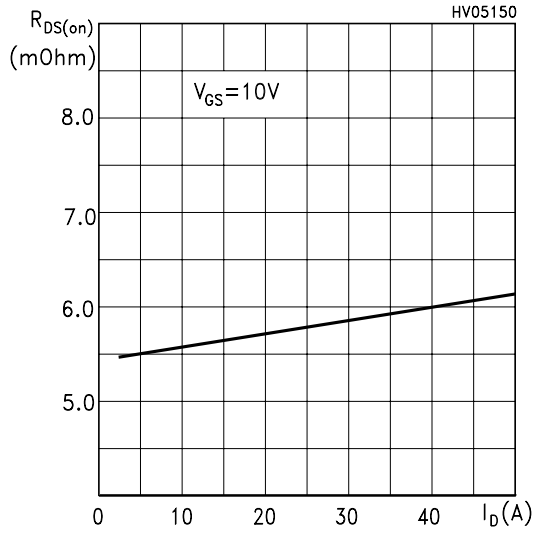
Transfer Characteristics



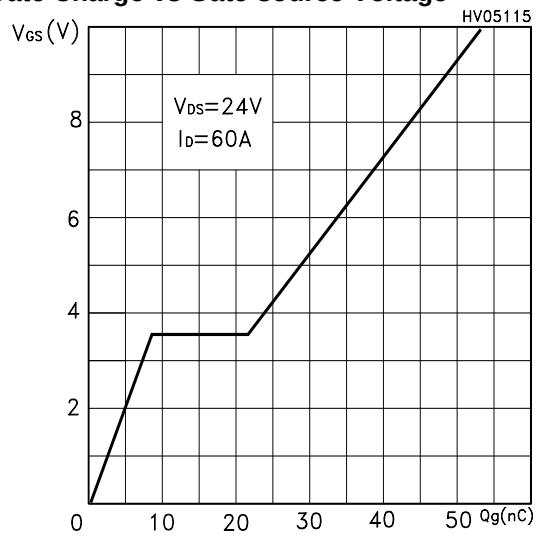
Transconductance



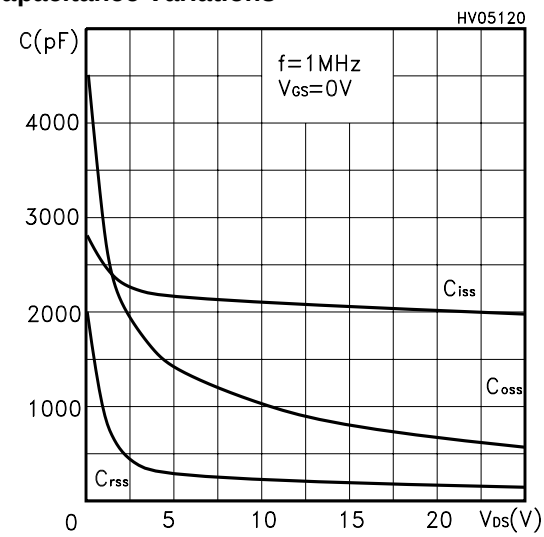
Static Drain-source On Resistance



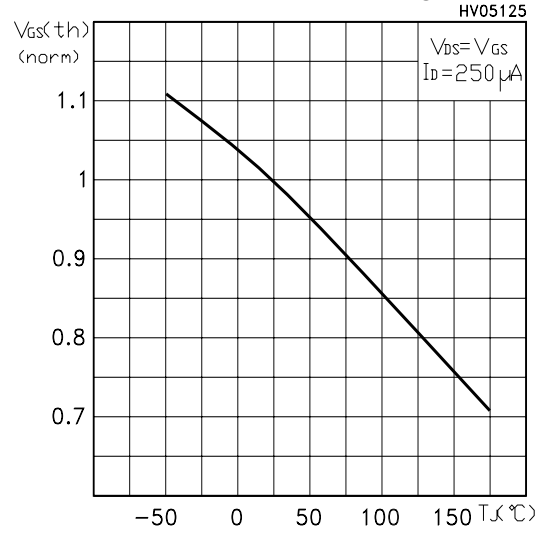
Gate Charge vs Gate-source Voltage



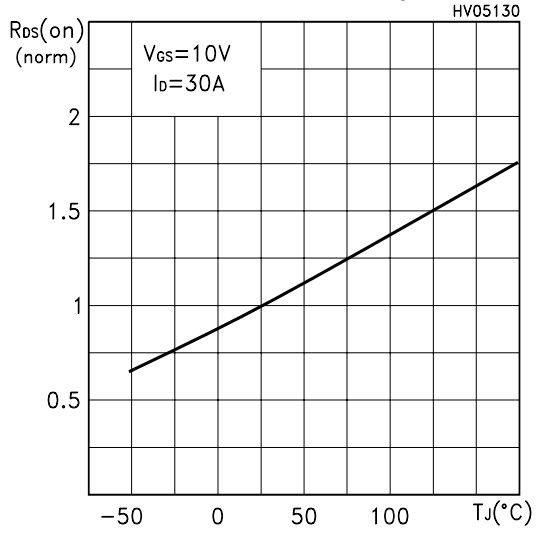
Capacitance Variations



Normalized Gate Thereshold Voltage vs Temp.



Normalized On Resistance vs Temperature



Source-drain Diode Forward Characteristics

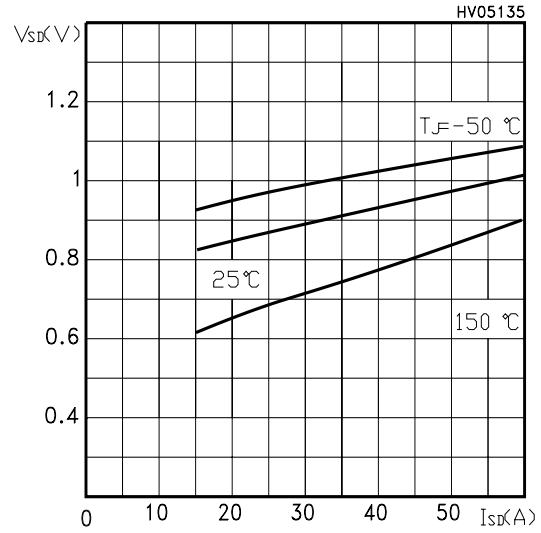


Fig. 1: Unclamped Inductive Load Test Circuit

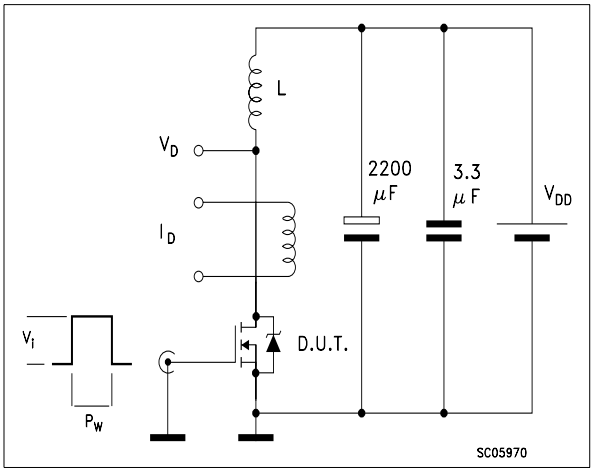


Fig. 2: Unclamped Inductive Waveform

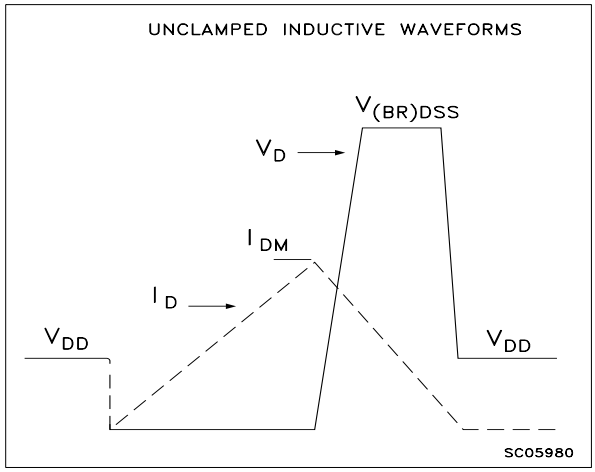


Fig. 3: Switching Times Test Circuit For Resistive Load

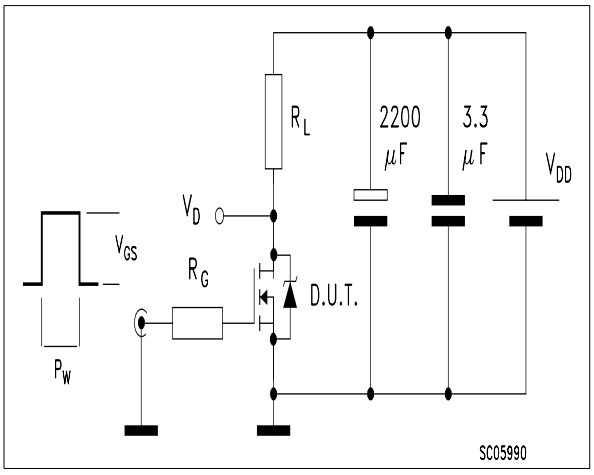


Fig. 4: Gate Charge test Circuit

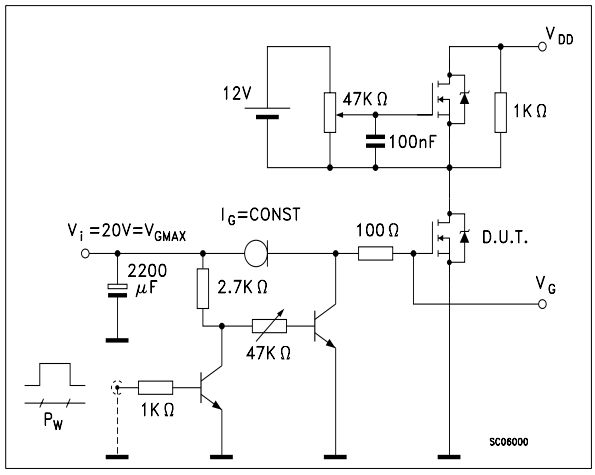
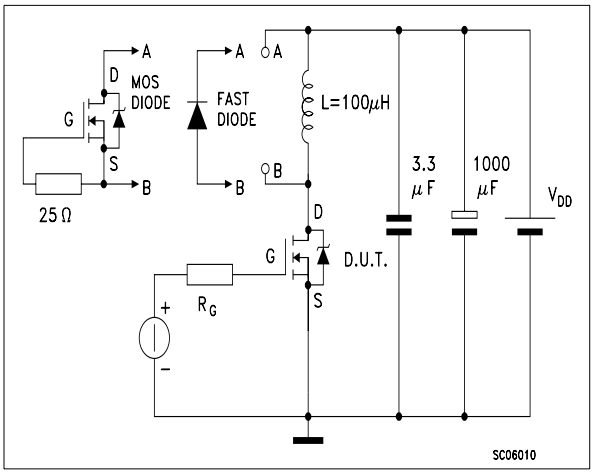
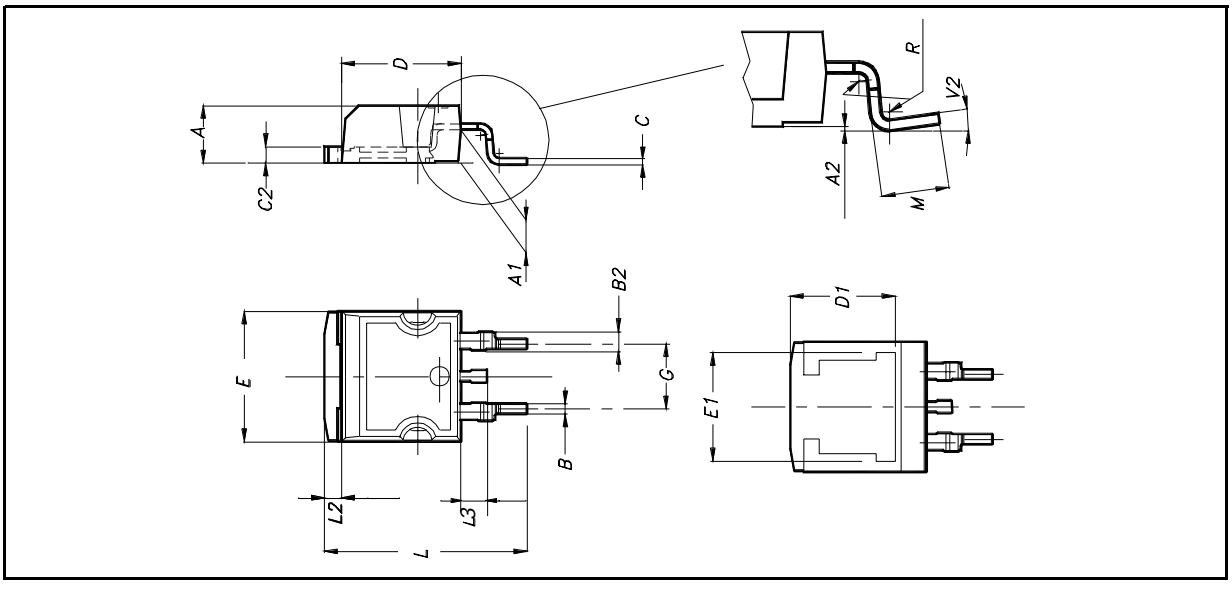


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

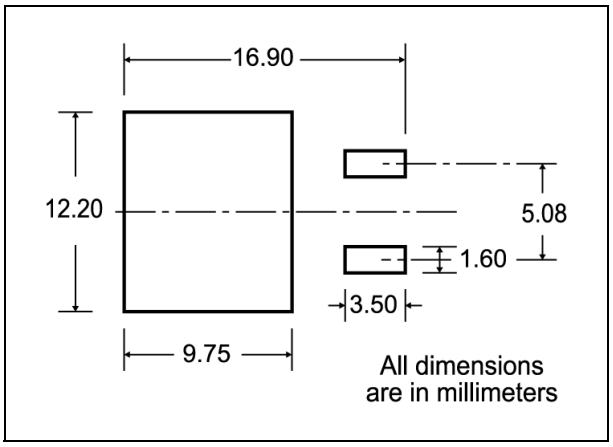


D²PAK MECHANICAL DATA

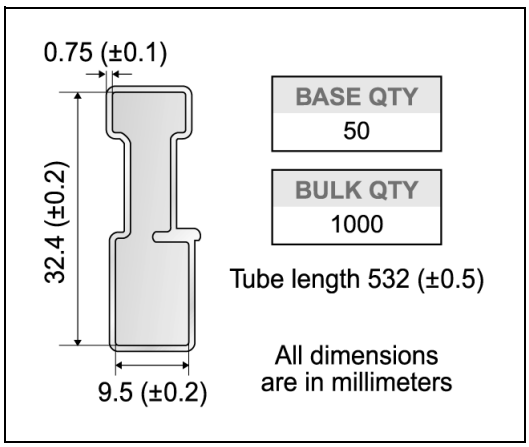
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
C	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8			0.315	
E	10		10.4	0.393		
E1		8.5			0.334	
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.625
L2	1.27		1.4	0.050		0.055
L3	1.4		1.75	0.055		0.068
M	2.4		3.2	0.094		0.126
R		0.4			0.015	
V2	0º		8º			



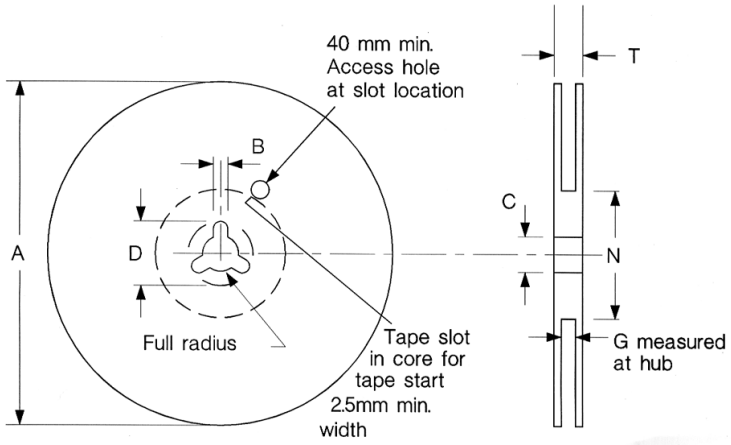
D²PAK FOOTPRINT



TUBE SHIPMENT (no suffix)*



TAPE AND REEL SHIPMENT (suffix "T4")*



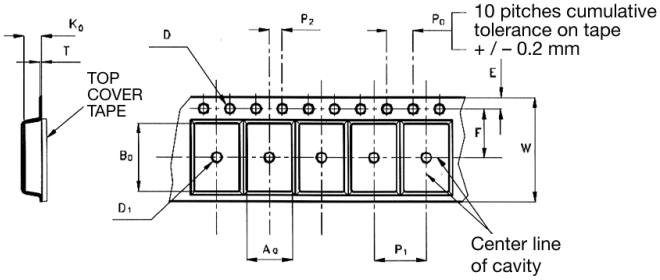
REEL MECHANICAL DATA

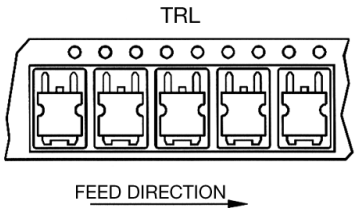
DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A		330		12.992
B	1.5		0.059	
C	12.8	13.2	0.504	0.520
D	20.2		0795	
G	24.4	26.4	0.960	1.039
N	100		3.937	
T		30.4		1.197

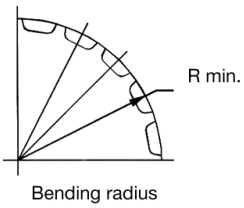
BASE QTY	BULK QTY
1000	1000

TAPE MECHANICAL DATA

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A0	10.5	10.7	0.413	0.421
B0	15.7	15.9	0.618	0.626
D	1.5	1.6	0.059	0.063
D1	1.59	1.61	0.062	0.063
E	1.65	1.85	0.065	0.073
F	11.4	11.6	0.449	0.456
K0	4.8	5.0	0.189	0.197
P0	3.9	4.1	0.153	0.161
P1	11.9	12.1	0.468	0.476
P2	1.9	2.1	0.075	0.082
R	50		1.574	
T	0.25	0.35	0.0098	0.0137
W	23.7	24.3	0.933	0.956







* on sales type